


 上海科技大学
 ShanghaiTech University

EE115 Analog Circuits Introduction

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Outline

- Course logistics
- History of electronics and microelectronics
- Need of analog electronics
- Why is it more challenging to design analog than digital circuitry?
- Why integrated and why CMOS?



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Course Information

- Lecture
 - Tuesday 8:15-9:55, Thursday (Even week) 8:15-9:55
 - Rm 1-501 SIST Bldg.
- Instructor
 - Prof. Haoyu Wang
 - Rm 1A-225 SIST Bldg., wanghy@shanghaitech.edu.cn
 - Office hours: Friday 3:00pm-5:00pm; other times by appointment
- Recitation:
 - Once every 2 lectures
 - Will be announced by TA in advance



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Teaching Assistants

	TA	TA	TA
Recitation & Grader			
Lab & Project			

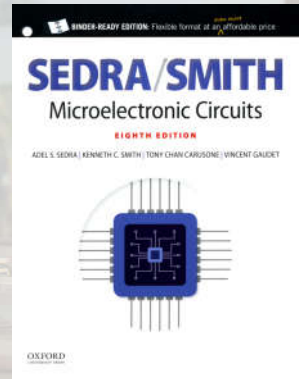


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Textbook



- Sedra/Smith, Microelectronic Circuits, 8th edition
 - Oxford University Press
- Minimum reading
 - Assigned sections in the website
- Best to read the relevant sections before lecture
 - Enables meaningful in class discussions



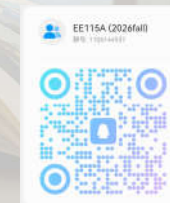
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Course Website



- Open website
 - General course info, lecture notes, hw problems
 - <https://pearl.shanghaitech.edu.cn/teaching/2025Fall/EE115/>
- Discussions
 - QQ group: 1106144537



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Homework



- Posted in course website & gradescope
- Due one week after it is posted
 - Will be collected in gradescope
 - <https://www.gradescope.com/courses/1368836>
 - Late homework will be discounted by 20% per day
 - Solution will be discussed in the recitation session
- Be prepared to spend **6-10 hours** to complete
 - Reading, problem solving
- You may discuss homework problems with other students in the class, the TAs, or the instructor.
- **The work you submit for grading must be your own**



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Grades



- Homework: 15%
 - Lowest score will be dropped from grade calculation
- Lab 15%
 - Led by Teacher LIU Chuang
- Midterm: 20%
- Project 15%
- **Final exam: 30%**
- Quiz: 5%
- **Cheating will result in automatic Fail!**



LIU Chuang
SIST 1B-206
liuchuang1@shanghaitech

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Midterm & Final Exams



- Midterm:
 - 11/5/2025 (Thur.) in class
- Final Exam:
 - 12/22/2025 (Tue.)

Week	Date	Lectures	Reading Syllabus/Text	HW & Project
1	9/16	Syllabus [PDF] Lecture 1 Introduction [PDF]	Chpt. 1, pp. 1-15	
	9/23	Lecture 2 Amp basics [PDF]	Chpt. 1, pp. 16-45	
2	9/25	Lecture 3 Ideal Op Amp [PDF]	Chpt. 2, pp. 58-62	HW1 [PDF] Due date: 10/7/2025
	9/28	Lecture 4 Non Ideal Op Amp [PDF]	Chpt. 2, pp. 97-116	
3	9/30	Lecture 5 Semiconductors [PDF]	Chpt. 3, pp. 138-149	HW2 [PDF] Due date: 10/14/2025
4	10/9	Lecture 6 PN Junction [PDF]	Chpt. 3, pp. 150-169	
5	10/14	Lecture 7 MOSFET [PDF]	Chpt. 4, pp. 244-284	HW3 [PDF] Due date: 10/21/2025
6	10/21	Lecture 8 Transistor Amp: basic principles & small signal operation [PDF]	Chpt. 7, pp. 386-392	
6	10/23	Lecture 9 Transistor Amp: basic configurations [PDF]	Chpt. 7, pp. 422-447	

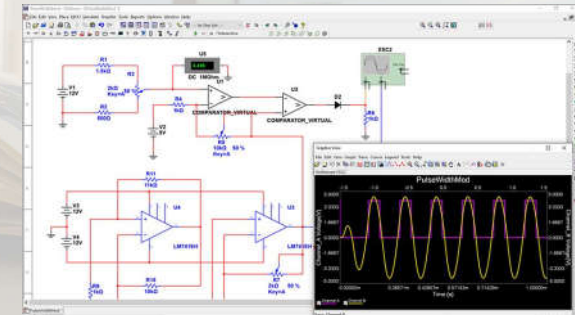


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Simulation Software



- SPICE (Simulation Program with Integrated Circuit Emphasis)
 - Multisim from National Instruments

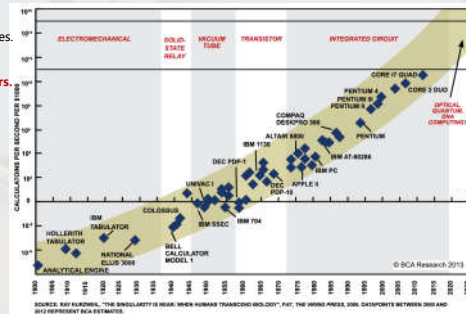


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Electronics Milestones



- 1874 Braun invents the **solid-state rectifier**.
- 1906 DeForest invents triode **vacuum tube**.
- 1907-27 First radio circuits developed from diodes and triodes.
- 1925 Lilienfeld field-effect device patent filed.
- 1947 Bardeen & Brattain at Bell Lab invent **bipolar transistors**.
- 1952 Commercial bipolar transistor production at TI.
- 1956 Bardeen, Brattain, and Shockley receive Nobel prize.
- 1958 **Integrated circuit** developed by Kilby and Noyce
- 1961 First commercial **IC** from Fairchild Semiconductor
- 1963 IEEE formed from merger of IRE and AIEE
- 1968 First commercial **IC op-amp**
- 1970 One transistor DRAM cell invented by Dennard at IBM.
- 1971 4004 Intel **microprocessor** introduced.
- 1974 8080 microprocessor introduced.
- 1978 First commercial 1-kilobit memory.
- 1984 Megabit memory chip introduced.
- 2000 Alferov, Kilby, and Kromer share Nobel prize



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Invention of Transistors - 1947



Bardeen, Shockley, and Brattain at Bell Labs - Brattain and Bardeen invented the **bipolar transistor** in 1947.

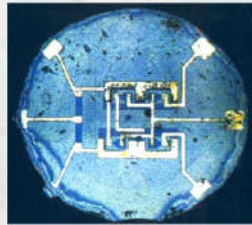


The first germanium bipolar transistor. Roughly 50 years later, electronics account for **10% of the world GDP**.



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The First Integrated Circuits - 1958

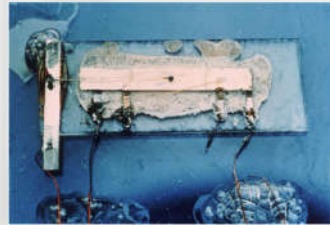


R. N. Noyce

Fairchild Semiconductor

Co-Founder of both Fairchild and Intel (deceased 1990)

Unitary Circuit made of Si



Jack Kilby

Texas Instruments

Invented IC during his first year at TI

(**Nobel Prize** 2000)

Solid Circuit made of Ge

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Evolution of Electronic Devices



Vacuum Tubes



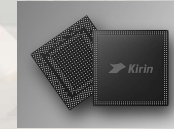
Discrete Transistors



SSI and MSI Integrated Circuits



VLSI Surface-Mount Circuits

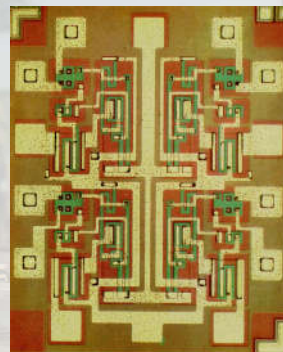


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Semiconductor Device Fabrication



Clean Room



IC micrograph

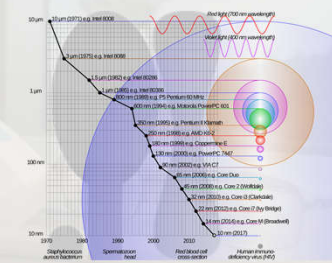
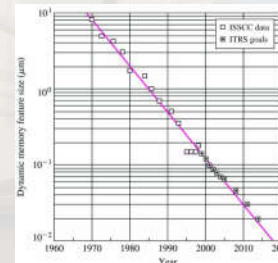


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Device Feature Size



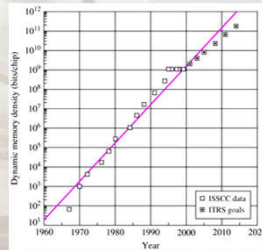
- Feature size reductions enabled by process innovations.
- Smaller features lead to more transistors per unit area and therefore higher density.
- 2020 5nm → 2022 3nm → **2025 2nm**



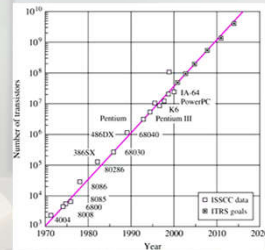
Moore's Law



- Number of transistors in an integrated circuit (IC) doubles about every two years.



Memory chip density versus time.



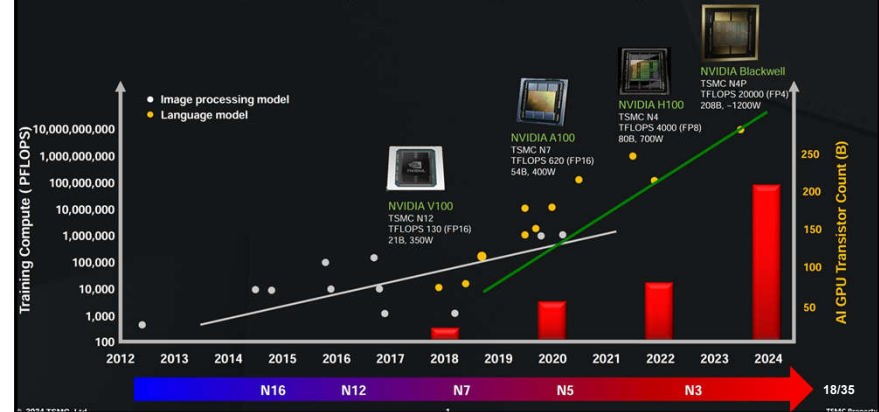
Microprocessor complexity versus time.



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Technology Advancement Ignites Explosive AI Growth

More Compute, Higher Memory Bandwidth, Larger Scale Heterogeneous Integration

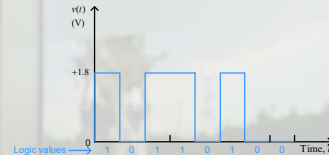
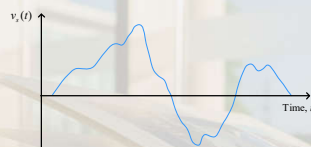


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Signal Type



- Analog** signals take on **continuous** values - typically current or voltage.



- Digital** signals appear at **discrete** levels. Usually we use binary signals which utilize only two levels.
- One level is referred to as **logical 1** and **logical 0** is assigned to the other level.

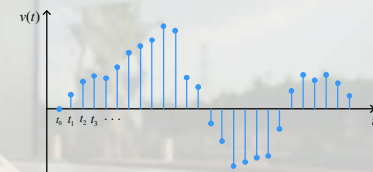
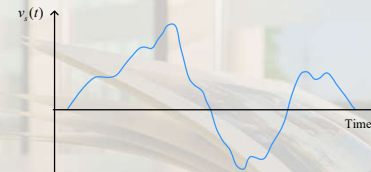


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Analog and Digital Signals



- Analog** signals are **continuous** in time and voltage or current. (Charge can also be used as a signal conveyor.)



- After **digitization**, the continuous analog signal becomes a set of discrete values, typically separated by fixed time intervals.



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Why Analog?

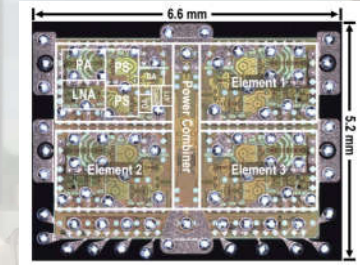
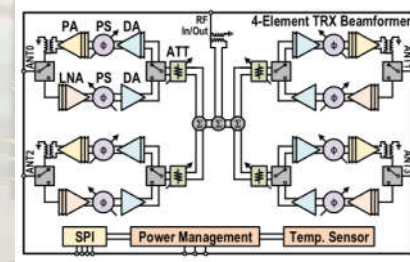
■ The real world is analog

- Analog is required to interface to just about anything
- Even to get two digital chips to talk to each other:



Another Example: RF Transceiver

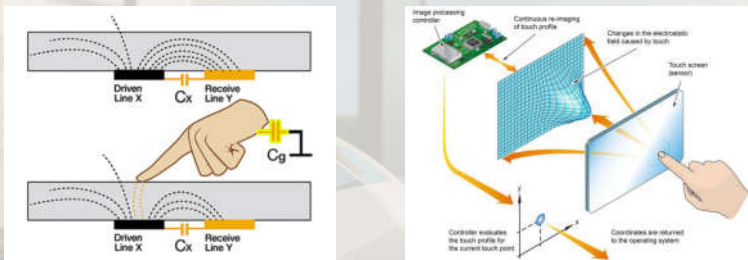
- Analog needs to provide **gain + filtering** with low noise and distortion



Yi et al.: 24–29.5-GHz HIGHLY LINEAR PHASED-ARRAY TRX FRONT-END IN 65-nm CMOS, JSSC 2022.

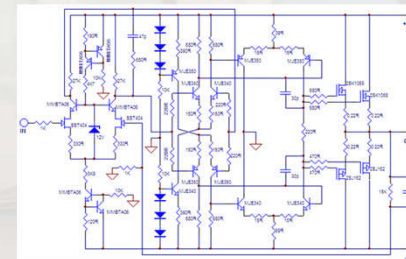
Capacitive Touch Sensors

- Similar to communications – analog needed for **signal conditioning**



Power Amplifier

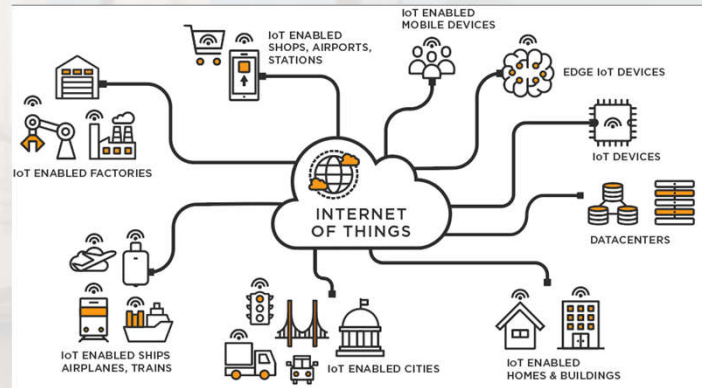
- A power amplifier (PA) converts a low-power signal to a higher power one.
 - Audio amplifiers, used to drive loudspeakers and headphones
 - RF power amplifiers, such as those used in the final stage of a transmitter.



HiFi Power Amplifier

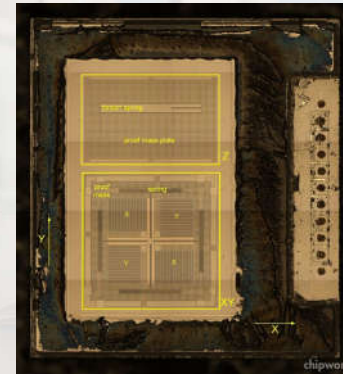


Internet of Things (IoT)

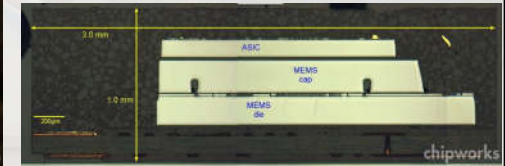


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Accelerometer

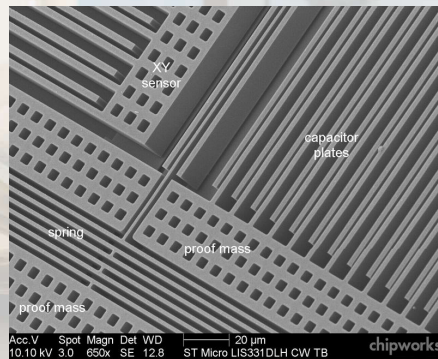


- ASIC stacked on Microelectromechanical Systems (MEMS)
- Wafer level packaging (WLP) for MEMS
- 2 polysilicon layer surface micromachining process



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Accelerometer

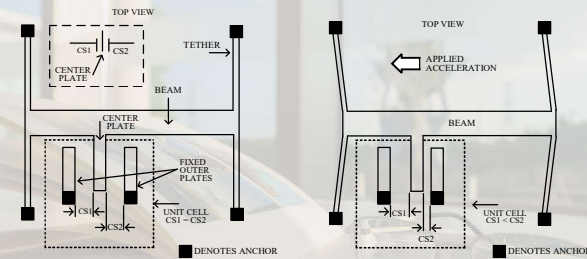


Acc.V Spot Magn Det WD
10.10 kV 3.0 650x SE 12.8
20 μm
ST Micro LIS331DLH CW TB

chipworks

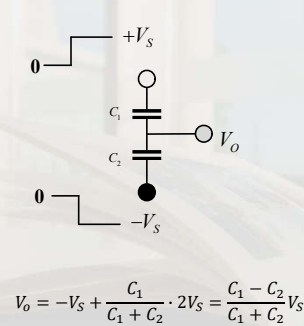
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Differential Capacitive Accelerometer



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Differential Capacitive Sensing



$$C_1 = C \frac{x_o}{x_o + \delta x} \quad C_2 = C \frac{x_o}{x_o - \delta x}$$

For small displacement:

$$C_1 - C_2 = C \left(\frac{x_o}{x_o + \delta x} - \frac{x_o}{x_o - \delta x} \right) \\ = C \frac{-2x_o \delta x}{x_o^2 - \delta x^2} \approx -C \frac{2}{x_o} \delta x$$

$$C_1 + C_2 \approx 2C$$

$$V_o \approx -\frac{\delta x}{x_o} V_s$$

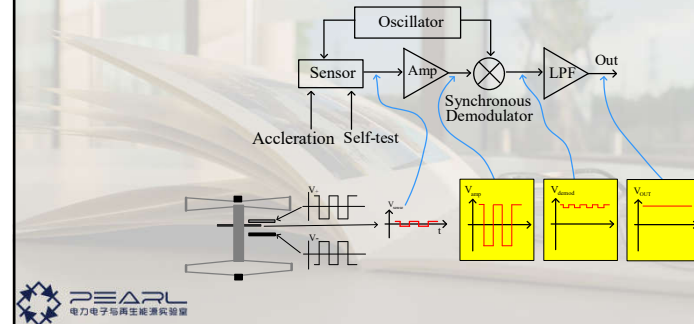
Output voltage $\propto$ displacement

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ADXL Block Diagram – Open Loop



- Minimum detectable capacitance change: 20 aF (aF = 10^{-18} F)
- Minimum detectable displacement: 0.02 nm (1/5 of hydrogen atom)



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Analog is more challenging than digital



- Digital entails primarily ONE trade-off: speed and power
- Analog face **multiple trade-offs** including **speed, power, gain, precision**, etc.
- Analog is significantly more **sensitive** to noise, crosstalk, and other interferences than digital.
- **Second-order effects** in devices influence more to analog than digital.
- Almost **zero automation** in analog, meaning every device needs to be hand-crafted.



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Why CMOS?



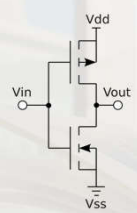
- Size of a transistor, gate length, has been **scaled down** from 25 μm in 1960 to **2 nm in 2025**.
- **MOSFETs** was patented in early 1930s far before the invention of **bipolar transistors**; technology becomes practical later in early 1960s. Yet, only n-type MOSFETs were produced. CMOS becomes available in mid-1960s.
- CMOS dissipates **power** only during switching and requires very few devices in contrast to bipolar.
- However, **MOSFETs** were slower and noisier than **biopolar**; i.e., g_m of MOSFETs $\ll g_m$ of BJT
- **Scalability and speed** of CMOS has championed for past 30 years !

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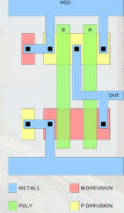
CMOS Circuit



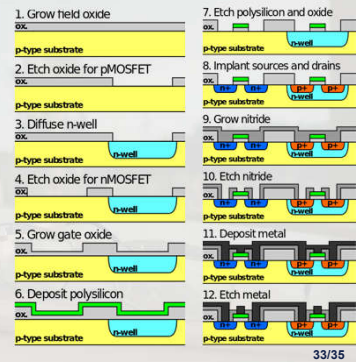
Inverter



Layout



Process Flow

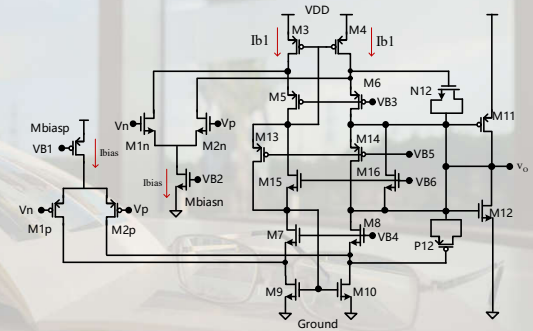


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What You Will Learn in EE115



TLV9062IDR SOP8
10MHZ Dual Low Voltage CMOS Op amp



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ShanghaiTech Circuit Courses



- Electric Circuits
- **Analog Circuits**
- Digital Circuits
- Analog Integrated Circuits I
- Digital Integrated Circuits I
- Power Electronics
- Advanced Analog Integrated Circuits (graduate course)
- Advanced Digital Integrated Circuits (graduate course)
- Radio Frequency Integrate Circuits (graduate course)



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